



Product Change Notice

PCN Type: ■HW/SYS				
PCN Number: P2015		Revision: A		Date of Publication: 04/15/2020
PRODUCT NAME	PRODUCT PART#	OLD — RE	V. — NEW	REVISION TYPE
BC87Q	70943-C	1.1	1.2	Hardware
W070	70005 0	(70942-C)	(70943-C)	-
RX87Q	70905-C	3.1 (70903-C)	3.2 (70905-C)	
		(70903-0)	(70905-C)	
EASON OF CHANG	E:			
he Trusted Platform	Module (TPM) 1.2 us	ed on the RX8	7Q and BC87	Q (Infineon SLB9635TT1.2) has been discontinu
vith no compatible re	eplacement.			
ESCRIPTION OF C	HANGE:			
			-	DM) of these two products. This phase out wi
•	•	scontinuance	date for these	e products of 2/26/2021 (see BCM Change
Notification #: E2014	01)			
MPACT OF CHANG	E AND RECOMMEN	D ACTION:		
-	thoroughly evaluate	d to ensure th	at there is no	quality, reliability or thermal implications to ou
ustomer.				
	nding our customer t	o perform add	itional qualifi	cation of this changes.
CM is not recommer	-	o perform add	itional qualifi	cation of this changes.
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Signature

Doc#: F-G0-0-007A